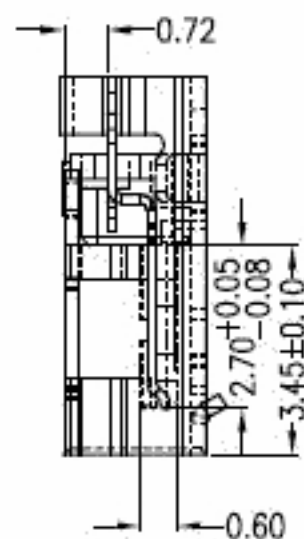
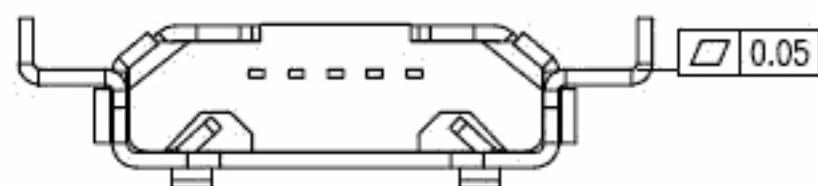
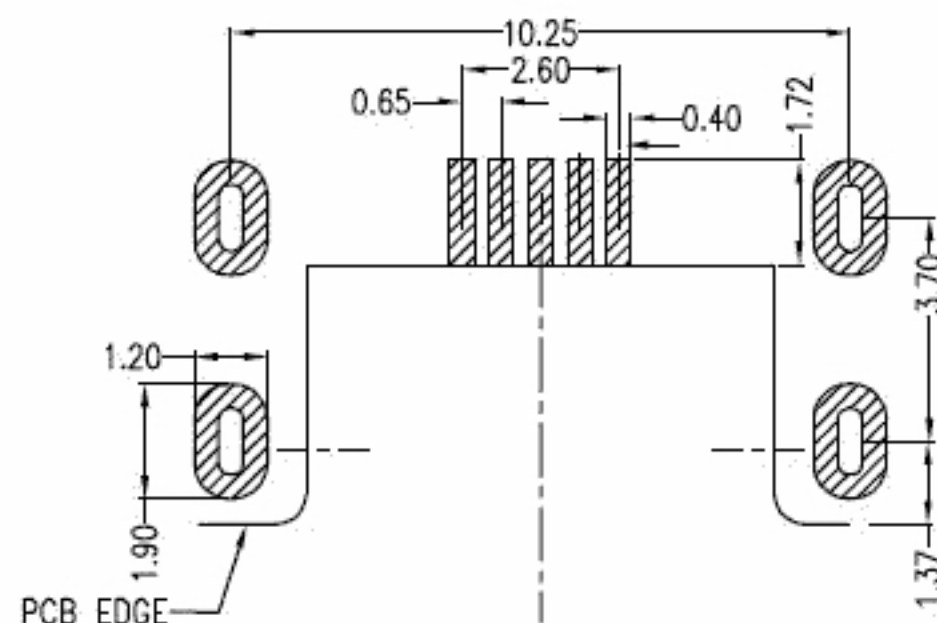
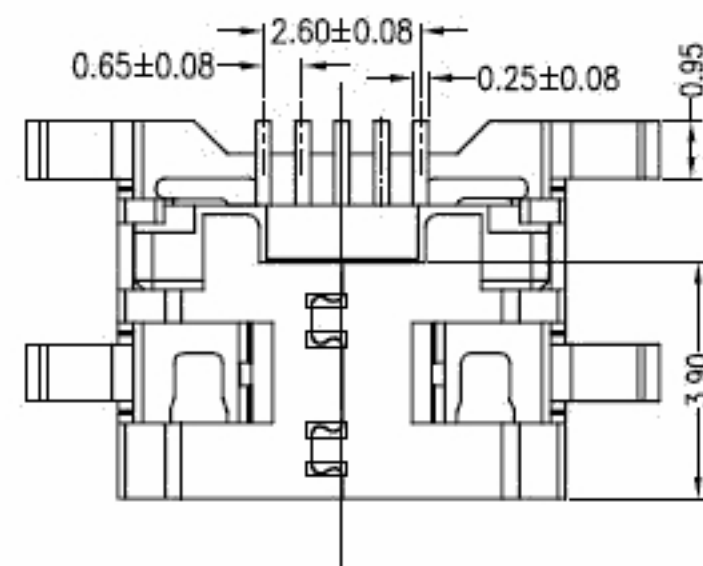
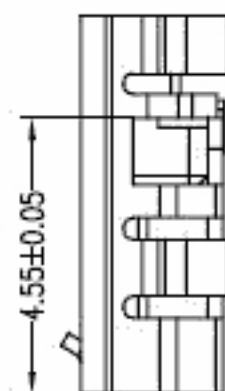
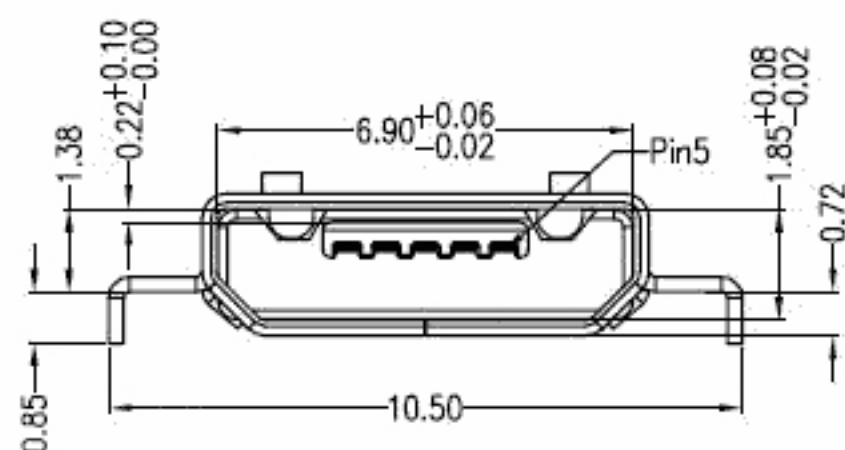
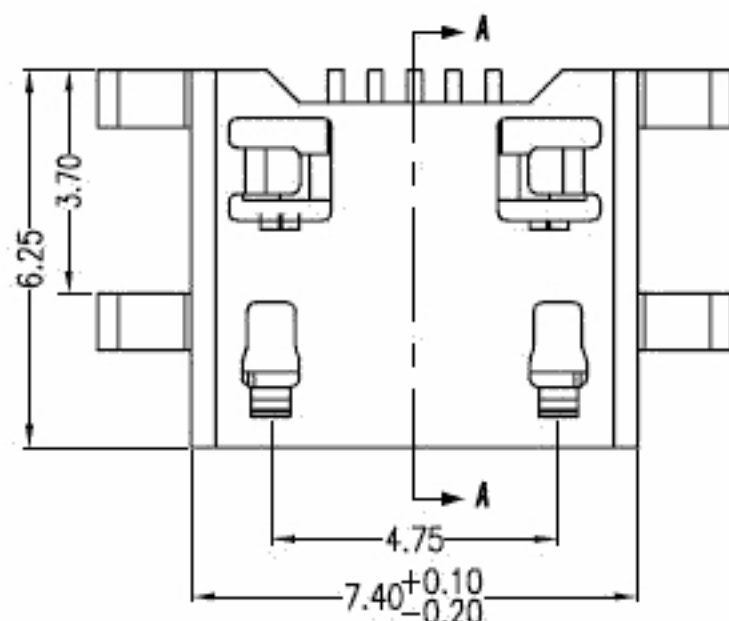




SEC A-A



RECOMMENDED PCB LAYOUT

Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:

- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 50 mW Max.
- 2.4 Insulation resistance: 100 MW Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

PART NO: A01SB141B3-259		MATERIAL: SEE NOTE			
MODEL NO: XX		FINSH: SEE NOTE			
UNIT: MM	SIZE: A4	COLOR: SEE NOTE		TITLE:	
TOLERANCE UNSPECIFIED .x 0.25 .xx 0.20 .xxx 0.15 Ang. 2°		DR: 夏友红		Micro usb 5s B Type Smt沉板式无导位无接地片	
		CHK:		DWG NO: A259	
		APP:		REV: A	
				SCALE: 5:1	
				DATE: 2012.06.18	
				